

● PRINTER RUSH ●

(PTO ASSISTANCE)

Application :	<u>10/647091</u>	Examiner :	<u>Datskovskiy</u>	GAU :	<u>2835</u>
From:	<u>MB</u>	Location:	<u>IDC</u>	FMF FDC	Date: <u>11-16-05</u>
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DOC CODE	DOC DATE	MISCELLANEOUS
<input type="checkbox"/> 1449		<input type="checkbox"/> Continuing Data
<input type="checkbox"/> IDS		<input type="checkbox"/> Foreign Priority
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<input type="checkbox"/> OATH		
<input type="checkbox"/> 312		
<input checked="" type="checkbox"/> SPEC	<u>8-21-2003</u>	

[RUSH] MESSAGE: Specification page 1 paragraph 1 is missing a U.S. Serial Number and date.

Thank you
MB

[XRUSH] RESPONSE:

DONE

INITIALS: MB

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REV 10/04

TITLE: TEMPERATURE CONTROL SYSTEM WHICH SPRAYS LIQUID COOLANT DROPLETS AGAINST AN IC-MODULE AND DIRECTS RADIATION AGAINST THE IC-MODULE

RELATED CASES:

The above-identified invention is related to one other invention which is described herein with a single Detailed Description. The other related invention 5 has U.S. Serial Number 10647090 and is entitled "TEMPERATURE CONTROL SYSTEM WHICH SPRAYS LIQUID COOLANT DROPLETS AGAINST AN IC-MODULE AT A SUB-ATMOSPHERIC PRESSURE". U.S. patent applications on both inventions were concurrently filed on August 21, 2003.

10 BACKGROUND OF THE INVENTION:

The present invention relates to temperature control systems for maintaining the temperature of an integrated circuit chip (IC-chip) near a constant set point temperature while the IC-chip is being tested. 15 Also the present invention relates to subassemblies which comprise key portions of the above temperature control systems.